

# AE417 (Preliminary)

# <u>RFHIO</u>

## **Product Features**

- Small size
- Higher linearity
- SOT89 SMD Type package
- Higher productivity
- Lower manufacturing cost
- -63dBc CSO 135 Channels @ +30dBmV/ch
- -74dBc CTB 135 Channels @ +30dBmV/ch
- -73dBc XMD 135 Channels @ +30dBmV/ch

### Application

- Low Noise Amplifier for
- CATV, Satellite • Cable Modem
- FTTH (G-PON, GE-PON)
- Optical node
- opticul lio



### Description

AE417 is designed as low cost drive amplifiers for many applications including FTTH, CATV System. This MMIC is based on Gallium Arsenide Enhancement Mode pHEMT which shows low current draw and very low noise. The data in this spec sheet is valid only for 75 ohm application.

#### **Specifications**

| PARAM                 | UNIT              | MIN TYP MAX |                | MAX | Condition  |                         |  |
|-----------------------|-------------------|-------------|----------------|-----|------------|-------------------------|--|
| Frequency             |                   | MHz         | $50 \sim 1000$ |     |            |                         |  |
| Ga                    | dB                |             | 11             |     |            |                         |  |
| Input Ret             | dB                |             | -19            |     |            |                         |  |
| Output Re             | dB                |             | -18            |     |            |                         |  |
| Output IP3            |                   | dBm         | 38 41          |     |            | At 500MHz/10dBm 2tone   |  |
| 1dB Compression Point |                   | dBm         | 22 24.8        |     |            | At 500MHz               |  |
| Noise Figure          |                   | dB          |                | 4   | 5          |                         |  |
| CSO                   |                   | dBc         |                | -63 | -58        | 135 channel, +30dBmV/ch |  |
| СТВ                   | $30 \sim 870 MHz$ | dBc         |                | -74 | -69        | 135 channel, +30dBmV/ch |  |
| XMOD                  |                   | dBc         |                | -73 | -68        | 135 channel, +30dBmV/ch |  |
| DC C                  | mA                |             | 115            |     | Vdd = 8.0V |                         |  |

#### NOTE

1. Test conditions unless otherwise noted. Test Freq = 500MHz, T=25  $^\circ\!\!\mathbb{C}$ , Vdd=8V, 75 $\Omega$  system

2. OIP3 measured with 2 tones at an output power of +10dBm/tone separated by 1MHz, Test Freq = 500MHz

#### **Absolute Minimum and Maximum Ratings**

| PARAMETER             | UNIT | MIN | ТҮР | MAX  |  |
|-----------------------|------|-----|-----|------|--|
| Device Voltage        | VDC  |     | +8  | +9   |  |
| Operating Temperature | °C   | -40 |     | +85  |  |
| Storage Temperature   | Ĉ    | -40 |     | +150 |  |

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Version 0.2

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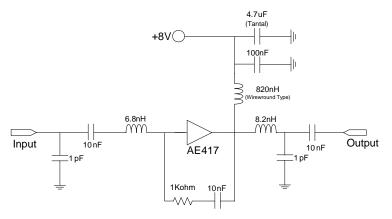
All specifications may change without notice.

**E-pHEMT MMIC** 

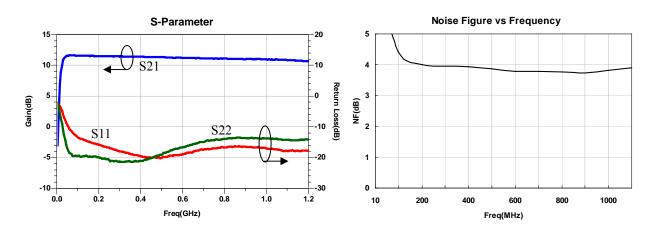
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# **RFHIC**

## O Application Circuit: 50MHz ~ 1000MHz, 750hm System



## ◎ Typical RF Performance: VDD=8V, IDs=115mA, T=25 °C, 75ohm System



### **O Multi-Tone Test 135CH\_FLAT@Output Power +30dBmV/Ch**

| Level: +3 | 30dBmV Tilt | t: 135CH_FLAT |         |       |         |         |         |         |         |         |
|-----------|-------------|---------------|---------|-------|---------|---------|---------|---------|---------|---------|
| FRQ       | XMD(NCTA)   | CTB_RAW       | CTB_COR | N-FLR | CSU_RAW | CSU_COR | CSU_FRQ | CSL_RAW | CSL_COR | CSL_FRQ |
| 55.25     | 73.8        | 74.8          | 79.1    | 75.6  | 75.4    | 79.8    | 56.09   | 63.4    | 63.6    | 54      |
| 77.25     | 75.2        | 75            | 79.3    | 75.6  | 63.9    | 64.2    | 77.99   | 75.3    | 79.7    | 76.45   |
| 109.25    | 75.9        | 74.8          | 79.1    | 75.8  | 75.1    | 79.4    | 110     | 64      | 64.3    | 107.99  |
| 211.25    | 75.1        | 74.6          | 78.9    | 75.8  | 75      | 79.3    | 211.98  | 64.2    | 64.4    | 209.99  |
| 331.25    | 75.9        | 72.8          | 77.1    | 74    | 72.7    | 77      | 331.99  | 64.2    | 64.6    | 329.99  |
| 445.25    | 74.9        | 73.5          | 77.8    | 75.6  | 72.9    | 76.5    | 446.49  | 64.5    | 64.9    | 443.99  |
| 547.25    | 73.9        | 71.9          | 76.2    | 73    | 70.6    | 74.2    | 548.49  | 64.2    | 64.8    | 545.99  |
| 637.25    | 74.4        | 71.6          | 75.9    | 73.3  | 69.4    | 71.6    | 638.49  | 65.3    | 66.1    | 635.98  |
| 745.25    | 74.5        | 71.6          | 76      | 73.7  | 67.8    | 69.2    | 746.49  | 67.4    | 68.7    | 743.99  |
| 859.25    | 73.9        | 70.3          | 74.6    | 71.2  | 66.2    | 67.8    | 860.49  | 70.3    | 74.6    | 858.49  |
|           |             |               |         |       |         |         |         |         |         |         |
| Min       | 73.8        | 70.3          | 74.6    | 71.2  | 63.9    | 64.2    | 56.09   | 63.4    | 63.6    | 54      |
| Max       | 75.9        | 75            | 79.3    | 75.8  | 75.4    | 79.8    | 860.49  | 75.3    | 79.7    | 858.49  |

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E-pHEMT MMIC

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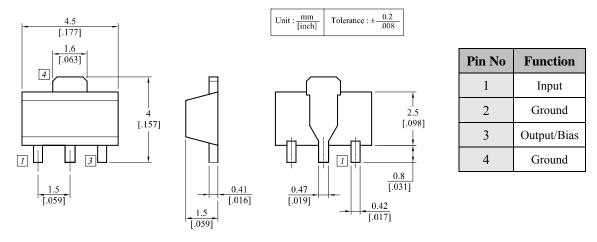
# **RFHIC**

#### **ESD** Protection

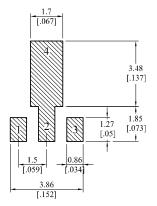
For a safe use in all situations, it is recommended to have proper ESD control techniques while the device is being handled. Here are some recommended precautions;

- Person at a workbench should be earthed via a wrist strap and a resistor.
- All mains-powered equipment should be connected to the mains via an earth-leakage switch.
- Equipment cases should be grounded.
- Relative humidity should be maintained between 40% and 50%.
- An ionizer is recommended.
- Keep static materials, such as plastic envelopes and plastic trays etc. away from the workbench

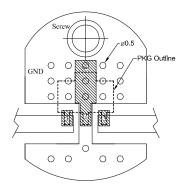
#### Dimensions



#### **PCB Pad Layout**



#### **Recommended Mounting Configuration**



#### **Mounting Configuration Notes**

1.Ground / thermal via holes are critical for the proper performance of this device.

- 2. Add as much copper as possible to inner and outer layers near the part to ensure optimal thermal performance.
- 3. Mounting screws can be added near the part to fasten the board to a heatsink. Ensure that the ground / thermal via hole region contacts the heatsink.
- 4. Do not put solder mask on the backside of the PCB in the region where the board contacts the heatsink.
- 5. RF trace width depends upon the PCB material and construction.
- 6. Use 1 oz. Copper minimum.
- 7. All dimensions are in millimeters.

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